

## DS15BA101 1.5 Gbps Differential Buffer with Adjustable Output Voltage

Check for Samples: [DS15BA101](#)

### FEATURES

- Data Rates from DC to 1.5+ Gbps
- Differential or Single-ended Input
- Adjustable Output Amplitude
- Single 3.3V Supply
- Industrial -40°C to +85°C Temperature
- Low Power: 150 mW (typ) at 1.5 Gbps
- Space-saving 3 x 3 mm WSON-8 Package

### APPLICATIONS

- Cable Extension Applications
- Level Translation
- Signal Buffering and Repeating
- Security Cameras

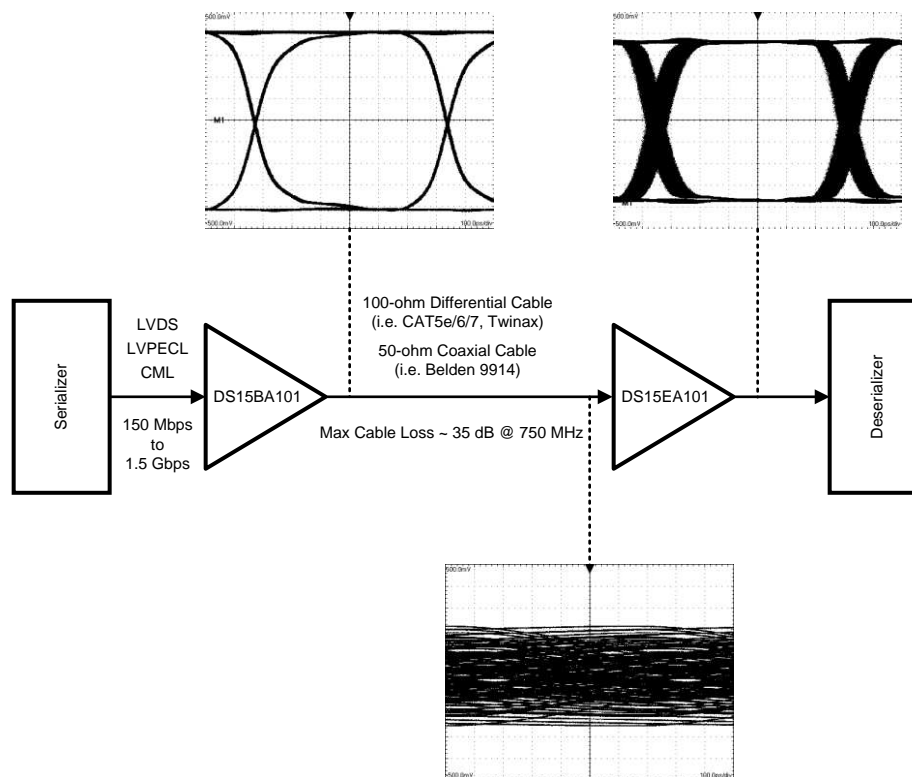
### DESCRIPTION

The DS15BA101 is a high-speed differential buffer for cable driving, level translation, signal buffering, and signal repeating applications. Its fully differential signal path ensures exceptional signal integrity and noise immunity and it drives both differential and single-ended transmission lines at data rates in excess of 1.5 Gbps.

Output voltage amplitude is adjustable via a single external resistor for level translation and cable driving applications into 50-ohm single-ended and 100-ohm differential mode impedances.

The DS15BA101 is powered from a single 3.3V supply and consumes 150 mW (typ) at 1.5 Gbps. It operates over the full -40°C to +85°C industrial temperature range and is available in a space saving 3x3 mm WSON-8 package.

### Typical Application



**Figure 1.**



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## Absolute Maximum Ratings<sup>(1)</sup>

Supply Voltage		-0.5V to 3.6V
Input Voltage (all inputs)		-0.3V to $V_{CC}+0.3V$
Output Current		28 mA
Storage Temperature Range		-65°C to +150°C
Junction Temperature		+150°C
Lead Temperature (Soldering 4 Sec)		+260°C
Package Thermal Resistance	$\theta_{JA}$ WSON-8	+90.7°C/W
	$\theta_{JC}$ WSON-8	+41.2°C/W
ESD Rating (HBM)		5 kV
ESD Rating (MM)		250V

- (1) "Absolute Maximum Ratings" are those parameter values beyond which the life and operation of the device cannot be guaranteed. The stating herein of these maximums shall not be construed to imply that the device can or should be operated at or beyond these values. The table of "Electrical Characteristics" specifies acceptable device operating conditions.

## Recommended Operating Conditions

Supply Voltage ( $V_{CC} - GND$ ):	3.3V $\pm 5\%$
Operating Free Air Temperature ( $T_A$ ) DS15BA101SD	-40°C to +85°C

## DC Electrical Characteristics

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified.<sup>(1)(2)</sup>

Symbol	Parameter	Conditions	Reference	Min	Typ	Max	Units
$V_{ICM}$	Input Common Mode Voltage	See <sup>(3)</sup>	IN+, IN-	0.8		$V_{CC} - V_{ID}/2$	V
$V_{ID}$	Differential Input Voltage Swing			100		2000	mV <sub>P-P</sub>
$V_{OS}$	Output Common Mode Voltage		OUT+, OUT-		$V_{CC} - V_{OUT}/2$		V
$V_{OUT}$	Output Voltage	Single-ended, 25 $\Omega$ load $R_{VO} = 953\Omega$ 1%,			400		mV <sub>P-P</sub>
		Single-ended, 25 $\Omega$ load $R_{VO} = 487\Omega$ 1%,			800		mV <sub>P-P</sub>
$I_{CC}$	Supply Current	See <sup>(4)</sup>			45	49	mA

- (1) Current flow into device pins is defined as positive. Current flow out of device pins is defined as negative. All voltages are stated referenced to GND.  
 (2) Typical values are stated for  $V_{CC} = +3.3V$  and  $T_A = +25^\circ C$ .  
 (3) Specification is guaranteed by characterization.  
 (4) Maximum  $I_{CC}$  is measured at  $V_{CC} = +3.465V$  and  $T_A = +70^\circ C$ .

## AC Electrical Characteristics

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified<sup>(1)</sup>.

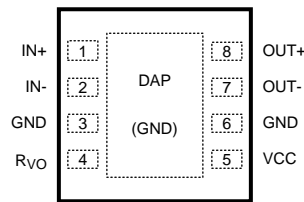
Symbol	Parameter	Conditions	Reference	Min	Typ	Max	Units
DR <sub>MAX</sub>	Maximum Data Rate	See <sup>(2)</sup>	IN+, IN-	1.5	2.0		Gbps
t <sub>LHT</sub>	Output Low to High Transition Time	20% – 80% <sup>(3)</sup>	OUT+, OUT-		120	220	ps
t <sub>HLT</sub>	Output High to Low Transition Time				120	220	ps
t <sub>PLHD</sub>	Propagation Low to High Delay	See <sup>(2)</sup>		0.95	1.10	1.35	ns
t <sub>PHLD</sub>	Propagation High to Low Delay	See <sup>(2)</sup>		0.95	1.10	1.35	ns
t <sub>TJ</sub>	Total Jitter	1.5 Gbps			26		pSp.p

(1) Typical values are stated for V<sub>CC</sub> = +3.3V and T<sub>A</sub> = +25°C.

(2) Specification is guaranteed by characterization.

(3) Specification is guaranteed by characterization and verified by test.

## CONNECTION DIAGRAM



**Figure 2. 8-Pad WSON  
See NGQ Package**

## PIN DESCRIPTIONS

Pin #	Name	Description
1	IN+	Non-inverting input pin.
2	IN-	Inverting input pin.
3	GND	Circuit common (ground reference).
4	R <sub>VO</sub>	Output voltage amplitude control. Connect a resistor to V <sub>CC</sub> to set output voltage.
5	V <sub>CC</sub>	Positive power supply (+3.3V).
6	GND	Circuit common (ground reference).
7	OUT-	Inverting output pin.
8	OUT+	Non-inverting output pin.

## DEVICE OPERATION

### INPUT INTERFACING

The DS15BA101 accepts either differential or single-ended input. The inputs are self-biased, allowing for simple AC or DC coupling. DC-coupled inputs must be kept within the specified common-mode range. The IN+ and IN- pins are self-biased at approximately 2.1V with  $V_{CC} = 3.3V$ . The following three figures illustrate typical DC-coupled interface to common differential drivers.

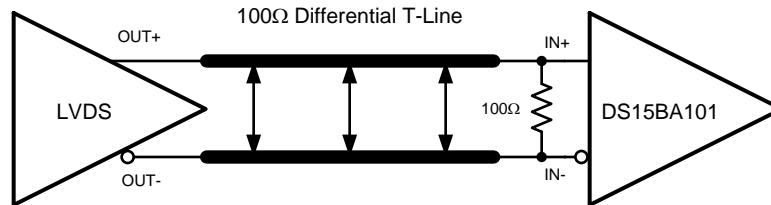


Figure 3. Typical LVDS Driver DC-Coupled Interface to DS15BA101 Input

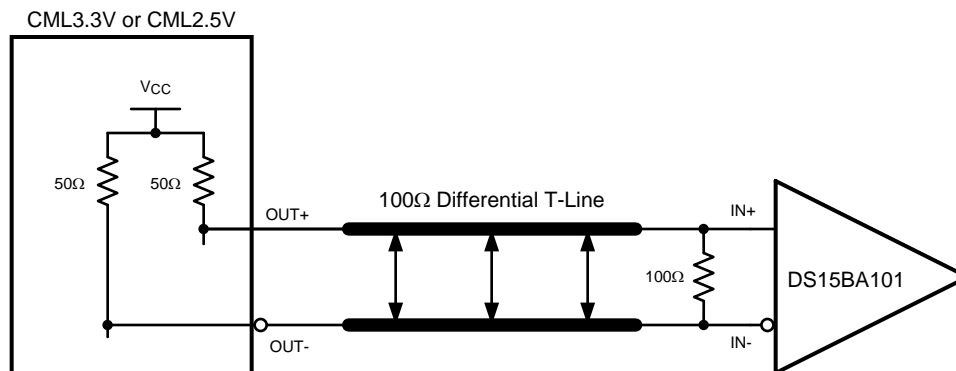


Figure 4. Typical CML Driver DC-Coupled Interface to DS15BA101 Input

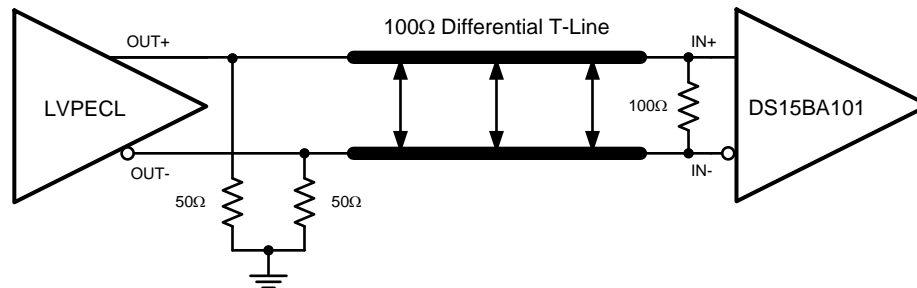


Figure 5. Typical LVPECL Driver DC-Coupled Interface to DS15BA101 Input

### OUTPUT INTERFACING

The DS15BA101 uses current mode outputs. Single-ended output levels are 400 mV<sub>P-P</sub> into AC-coupled 100Ω differential cable (with  $R_{VO} = 953\Omega$ ) or into AC-coupled 50Ω coaxial cable (with  $R_{VO} = 487\Omega$ ). Output level is controlled by the value of the  $R_{VO}$  resistor connected between the  $R_{VO}$  and  $V_{CC}$ .

The  $R_{VO}$  resistor should be placed as close as possible to the  $R_{VO}$  pin. In addition, the copper in the plane layers below the  $R_{VO}$  network should be removed to minimize parasitic capacitance. The following figure illustrates typical DC-coupled interface to common differential receivers and assumes that the receivers have high impedance inputs. While most receivers have a common mode input range that can accommodate CML signals, it is recommended to check respective receiver's datasheet prior to implementing the suggested interface implementation.

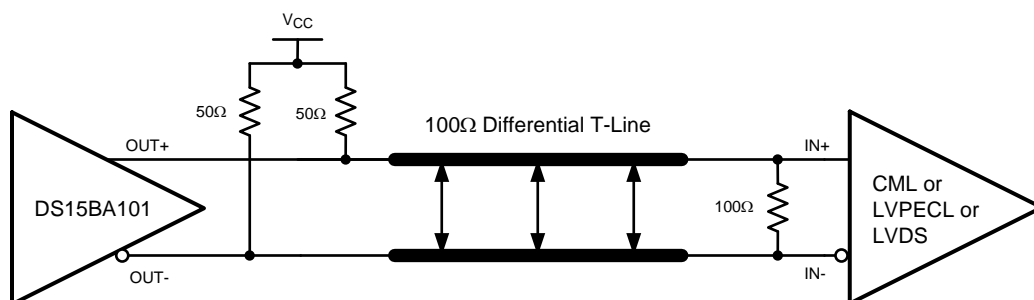


Figure 6. Typical DS15BA101 Output DC-Coupled Interface to an LVDS, CML or LVPECL Receiver

## CABLE EXTENDER APPLICATION

The DS15BA101 together with the DS15EA101 form a cable extender chipset optimized for extending serial data streams from serializer/deserializer (SerDes) pairs and field programmable gate arrays (FPGAs) over 100Ω differential (i.e. CAT5e/6/7 and twinax) and 50Ω coaxial cables. Setting correct DS15BA101 output amplitude and proper cable termination are keys for optimal operation. The following two figures show recommended chipset configuration for 100Ω differential and 50Ω coaxial cables.

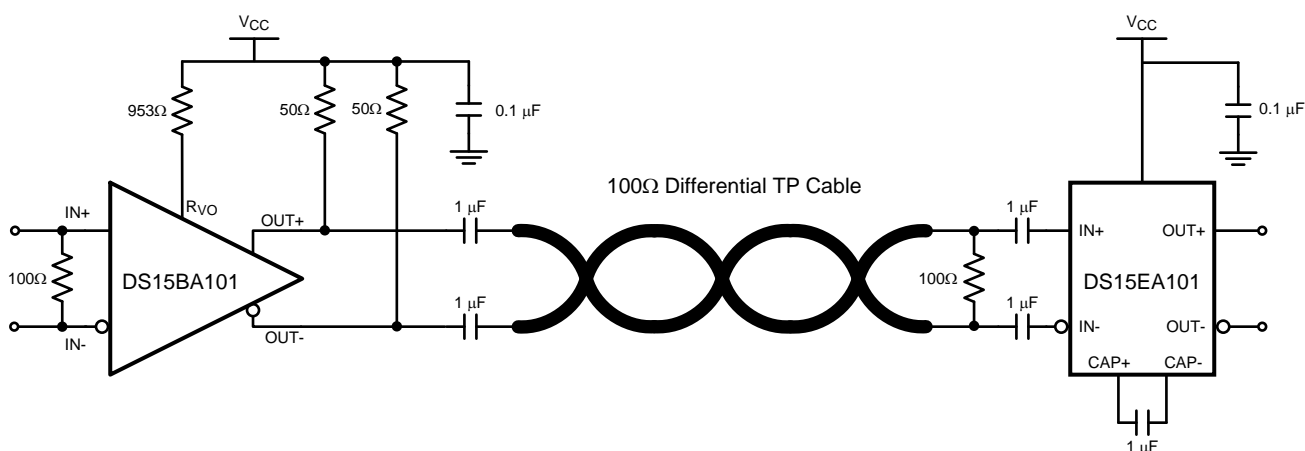


Figure 7. Cable Extender Chipset Connection Diagram for 100Ω Differential Cables

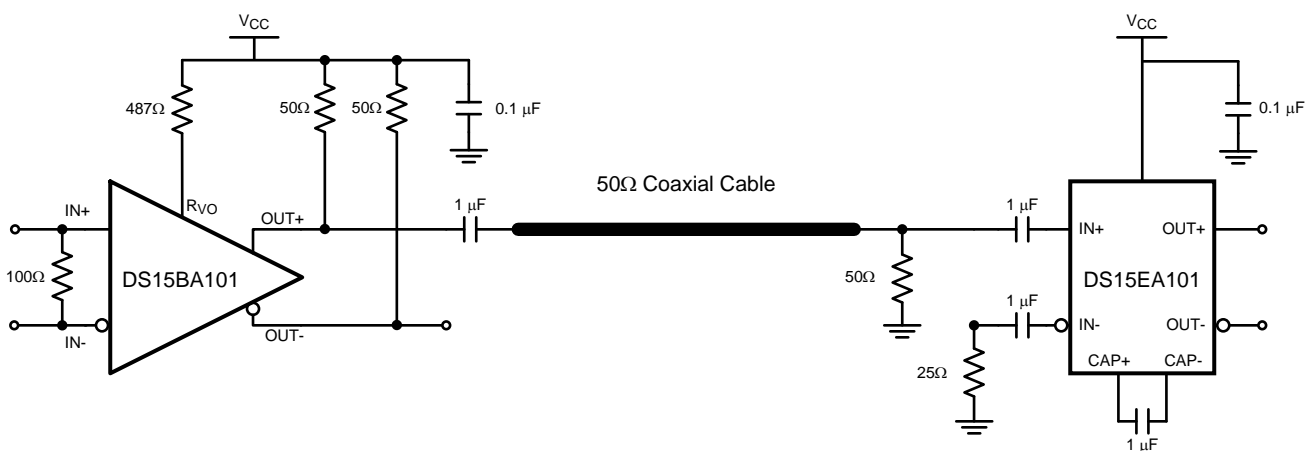
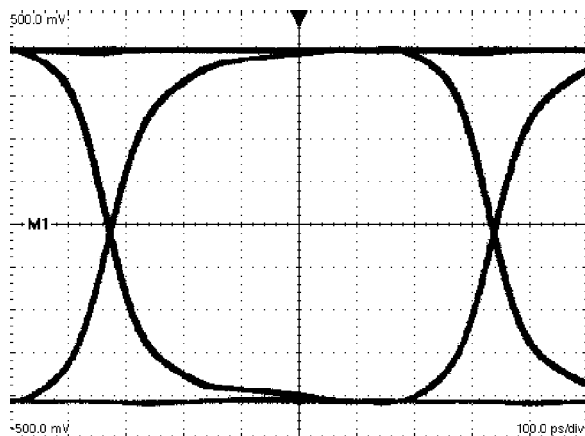


Figure 8. Cable Extender Chipset Connection Diagram for 50Ω Coaxial Cables

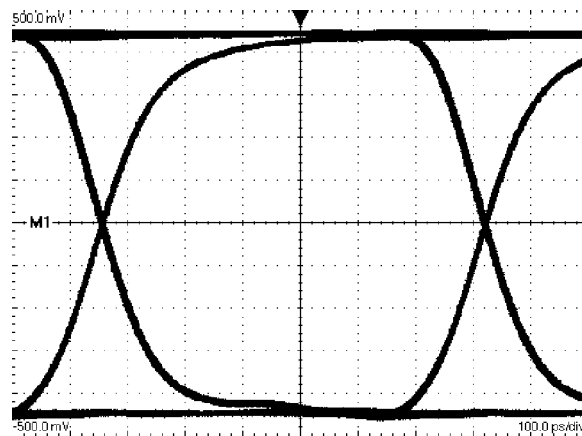
## REFERENCE DESIGN

There is a complete reference design (P/N: DriveCable02EVK) available for evaluation of the cable extender chipset (DS15BA101 and DS15EA101). For more information, visit <http://www.ti.com/tool/drivecable02evk>.

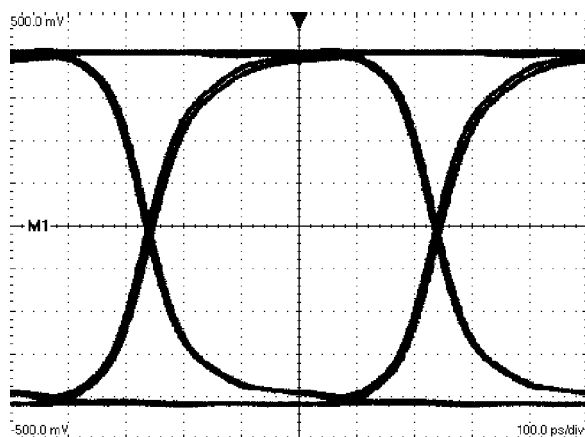
### Typical Performance



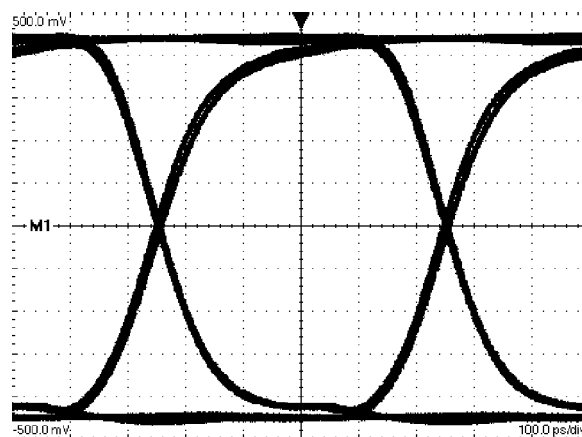
**Figure 9. 1.5 Gbps Differential DS15BA101 Output**  
 $R_{VO} = 953\Omega$ , H:100 ps / DIV, V:100 mV / DIV



**Figure 10. 1.5 Gbps Single-ended DS15BA101 Output**  
 $R_{VO} = 487\Omega$ , H:100 ps / DIV, V:100 mV / DIV



**Figure 11. 2.0 Gbps Differential DS15BA101 Output**  
 $R_{VO} = 953\Omega$ , H:100 ps / DIV, V:100 mV / DIV



**Figure 12. 2.0 Gbps Single-ended DS15BA101 Output**  
 $R_{VO} = 487\Omega$ , H:100 ps / DIV, V:100 mV / DIV

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
DS15BA101SD/NOPB	ACTIVE	WSON	NGQ	8	1000	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 85	BA101	<a href="#">Samples</a>
DS15BA101SDE/NOPB	ACTIVE	WSON	NGQ	8	250	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 85	BA101	<a href="#">Samples</a>
DS15BA101SDX/NOPB	ACTIVE	WSON	NGQ	8	4500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 85	BA101	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

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**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Only one of markings shown within the brackets will appear on the physical device.

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**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
DS15BA101SD/NOPB	WSO	NGQ	8	1000	178.0	12.4	3.3	3.3	1.0	8.0	12.0	Q1
DS15BA101SDE/NOPB	WSO	NGQ	8	250	178.0	12.4	3.3	3.3	1.0	8.0	12.0	Q1
DS15BA101SDX/NOPB	WSO	NGQ	8	4500	330.0	12.4	3.3	3.3	1.0	8.0	12.0	Q1



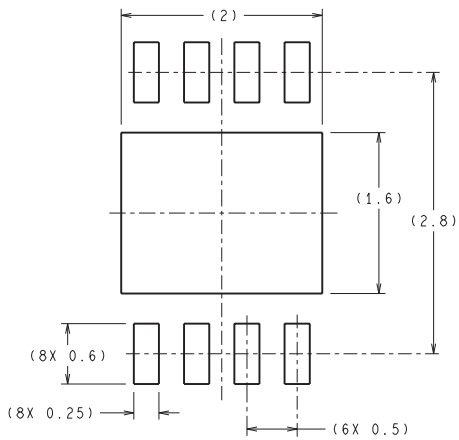
## TAPE AND REEL BOX DIMENSIONS



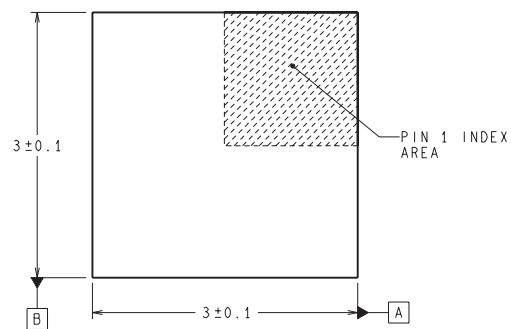
\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
DS15BA101SD/NOPB	WSO	NGQ	8	1000	213.0	191.0	55.0
DS15BA101SDE/NOPB	WSO	NGQ	8	250	213.0	191.0	55.0
DS15BA101SDX/NOPB	WSO	NGQ	8	4500	367.0	367.0	35.0

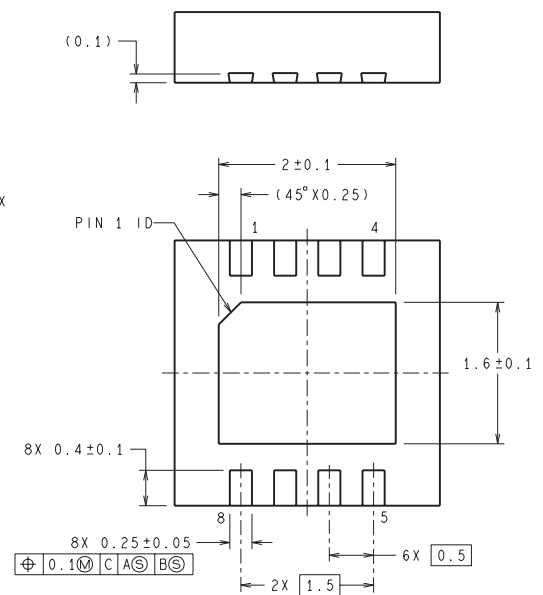
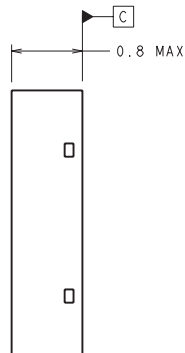
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SDA08A (Rev A)

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